

Features

- Dual data-rate of I.25Gbps/I.063Gbps operation
- I 550nm DFB laser and PIN photodetector for 80km transmission
- Compliant with SFP MSA and SFF-8472 with simplex LC receptacle
- Digital Diagnostic
 Monitoring:
 Internal Calibration or
 External Calibration
- Compatible with RoHS
- +3.3V single power supply
- Operating case temperature: Standard: 0 to +70°C

I.25Gbps SFP Bi-Directional Transceiver, 80km Reach

1550 nm TX/1490 nm RX

XSB541-80LY

Applications

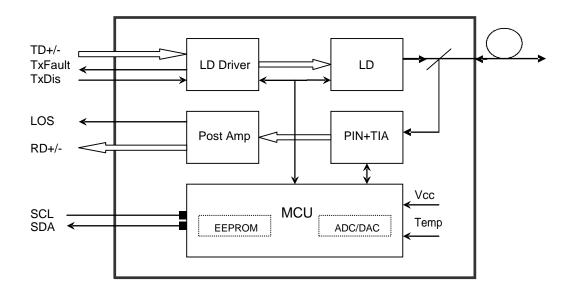
- o Gigabit Ethernet
- Fiber Channel
- Switch to Switch interface
- Switched backplane applications
- Router/Server interface
- Other optical transmission systems

Description

The SFP-BIDI transceivers are high performance, cost effective modules supporting dual data-rate of 1.25Gbps/1.0625Gbps and 80km transmission distance with SMF.

The transceiver consists of three sections: a DFB laser transmitter, a PIN photodiode integrated with a trans-impedance preamplifier (TIA) and MCU control unit. All modules satisfy class I laser safety requirements.

The transceivers are compatible with SFP Multi-Source Agreement (MSA) and SFF-8472. For further information, please refer to SFP MSA.



Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit
Supply Voltage	Vcc	-0.5	4.5	V
Storage Temperature	Ts	-40	+85	°C
Operating Humidity	-	5	85	%

Recommended Operating Conditions

	Parameter		Symbol	Min	Typical	Max	Unit
Operating C	Case Temperature	Commercial	Тс	0		+70	°C
Power Supply Voltage		Vcc	3.13	3.3	3.47	V	
Power Supply Current		Icc			300	mA	
D . D .	Gigabit Ethernet				1.25		O.
Data Rate	Fiber Cha	hannel 1.063		Gbps			

Optical and Electrical Characteristics

Para	meter	Symbol	Min	Typical	Max	Unit	Notes
			Transmitt	ter			
Centre Wavelen	gth	λς	1530	1550	1570	nm	
Spectral Width (-20dB)	Δλ			1	nm	
Side Mode Supp	ression Ratio	SMSR	30			dB	
Average Output	Power	Pout	-2		+3	dBm	1
Extinction Ratio		ER	9			dB	
Optical Rise/Fall	Time (20%~80%)	tr/tf			0.26	ns	
Data Input Swing	g Differential	VIN	400		1800	mV	2
Input Differential	Impedance	ZIN	90	100	110	Ω	
TX Disable	Disable		2.0		Vcc	V	
	Enable		0		0.8	V	
TV = 1	Fault		2.0		Vcc	V	
TX Fault	Normal		0		0.8	V	
			Receive	r			
Centre Wavelen	gth	λς	1470		1510	nm	
Receiver Power	Low				-25	dBm	3
Receiver Power	High		0			dBm	3
Receiver Overloa	ad		0			dBm	3
LOS De-Assert		LOSD			-25	dBm	
LOS Assert		LOSA	-35			dBm	
LOS Hysteresis			1		4	dB	
Data Output Swi	ng Differential	Vout	400		1800	mV	4
LOS		High	2.0		Vcc	V	
LUS		Low			0.8	V	

Notes:

The optical power is launched into SMF.
 PECL input, internally AC-coupled and terminated.
 Measured with a PRBS 2⁷-1 test pattern @1250Mbps, BER ≤1×10⁻¹². Internally AC-coupled.

Timing and Electrical Characteristics

Parameter	Symbol	Min	Typical	Max	Unit
Tx Disable Negate Time	t_on			1	ms
Tx Disable Assert Time	t_off			10	μs
Time To Initialize, including Reset of Tx Fault	t_init			300	ms
Tx Fault Assert Time	t_fault			100	μs
Tx Disable To Reset	t_reset	10			μs
LOS Assert Time	t_loss_on			100	μs
LOS De-assert Time	t_loss_off			100	μs
Serial ID Clock Rate	f_serial_clock			400	KHz
MOD_DEF (0:2)-High	Vн	2		Vcc	V
MOD_DEF (0:2)-Low	VL			0.8	V

Diagnostics Specification

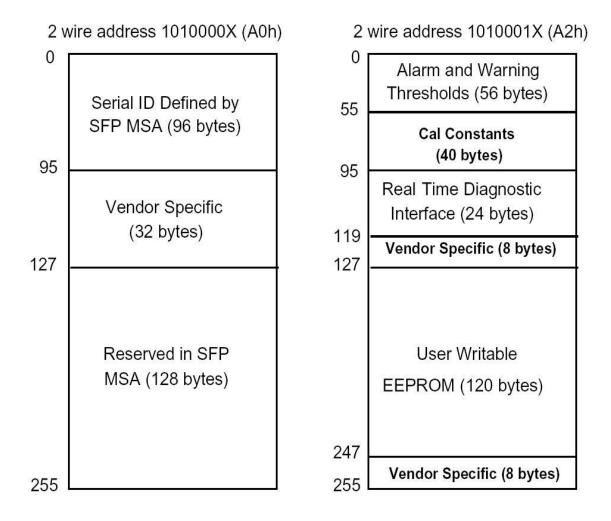
Parameter	Range	Unit	Accuracy	Calibration
Temperature	0 to +70	°C	±3°C	Internal / External
Voltage	3.0 to 3.6	V	±3%	Internal / External
Bias Current	0 to 100	mA	±10%	Internal / External
TX Power	-2 to +3	dBm	±3dB	Internal / External
RX Power	-25 to -3	dBm	±3dB	Internal / External

Digital Diagnostic Memory Map

The transceivers provide serial ID memory contents and diagnostic information about the present operating conditions by the 2-wire serial interface (SCL, SDA).

The diagnostic information with internal calibration or external calibration all are implemented, including received power monitoring, transmitted power monitoring, bias current monitoring, supply voltage monitoring and temperature monitoring.

The digital diagnostic memory map specific data field defines as following.



Pin Definitions

Pin Diagram

20	VeeT]	VeeT
19	TD-	2	TxFault
18	TD+	3	Tx Disable
17	VeeT] 4	MOD-DEF(2)
16	VccT	5	MOD-DEF(1)
15	VccR	6	MOD-DEF(0)
14	VeeR] 7	Rate Select
13	RD+	8	LOS
12	RD-	9	VeeR
11	VeeR] 10	VeeR
	Top of Board	Bott	om of Board (as viewe thru top of board)

Pin Descriptions

Pin	Signal Name	Description	Plug Seq.	Notes
1	VEET	Transmitter Ground	1	
2	TX FAULT	Transmitter Fault Indication	3	Note 1
3	TX DISABLE	Transmitter Disable	3	Note 2
4	MOD_DEF(2)	SDA Serial Data Signal	3	Note 3
5	MOD_DEF(1)	SCL Serial Clock Signal	3	Note 3
6	MOD_DEF(0)	TTL Low	3	Note 3
7	Rate Select	Not Connected	3	
8	LOS	Loss of Signal	3	Note 4
9	VEER	Receiver ground	1	Ï
10	VEER	Receiver ground	1	
11	VEER	Receiver ground	1	
12	RD-	Inv. Received Data Out	3	Note 5
13	RD+	Received Data Out	3	Note 5
14	VEER	Receiver ground	1	
15	Vccr	Receiver Power Supply	2	
16	Vсст	Transmitter Power Supply	2	
17	VEET	Transmitter Ground	1	
18	TD+	Transmit Data In	3	Note 6
19	TD-	Inv. Transmit Data In	3	Note 6
20	VEET	Transmitter Ground	1	

Notes:

Plug Seq.: Pin engagement sequence during hot plugging.

- 1) TX Fault is an open collector output, which should be pulled up with a 4.7k~10kΩ resistor on the host board to a voltage between 2.0V and Vcc+0.3V. Logic 0 indicates normal operation; Logic 1 indicates a laser fault of some kind. In the low state, the output will be pulled to less than 0.8V.
- 2) TX Disable is an input that is used to shut down the transmitter optical output. It is pulled up within the module with a 4.7k~10kΩ resistor. Its states are:

Low (0 to 0.8V): Transmitter on (>0.8V, < 2.0V): Undefined

High (2.0 to 3.465V): Transmitter Disabled Open: Transmitter Disabled

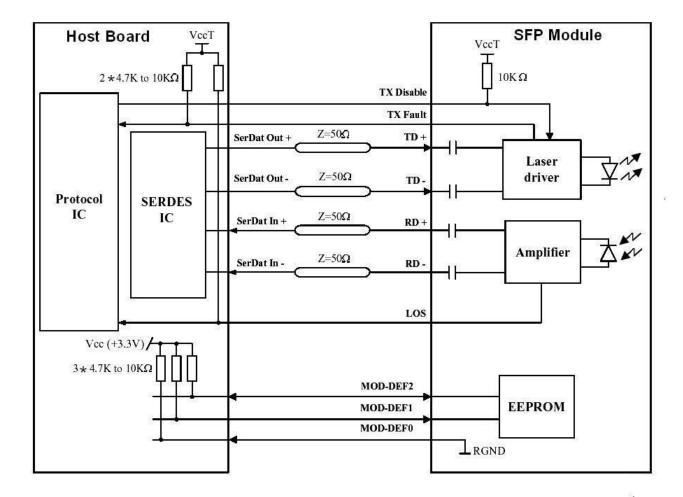
3) Mod-Def 0,1,2. These are the module definition pins. They should be pulled up with a $4.7k\sim10k\Omega$ resistor on the host board. The pull-up voltage shall be VccT or VccR.

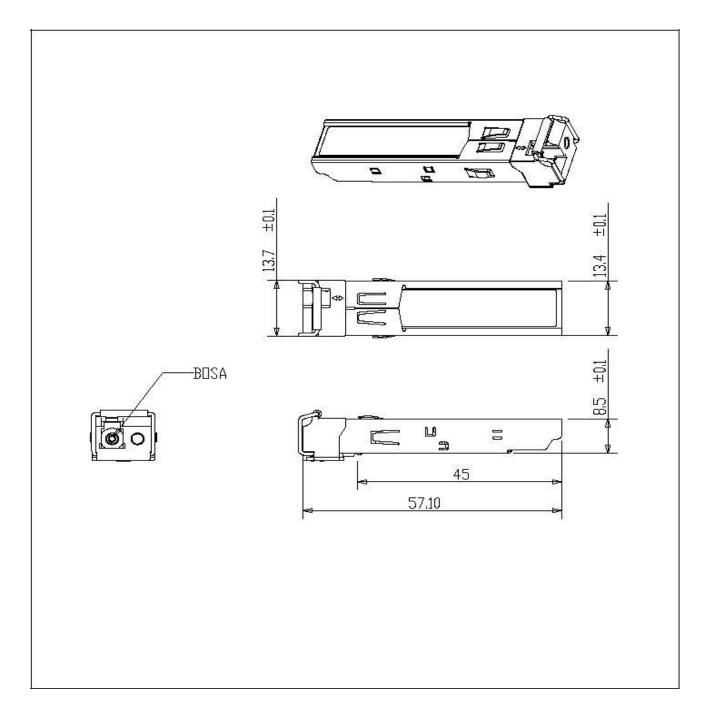
Mod-Def 0 is grounded by the module to indicate that the present Mod-Def 1 is the clock line of two wire serial interface for serial ID

Mod-Def 2 is the data line of two wire serial interface for serial ID

- 4) LOS is an open collector output, which should be pulled up with a 4.7k~10kΩ resistor. Pull up voltage between 2.0V and Vcc+0.3V. Logic 1 indicates loss of signal; Logic 0 indicates normal operation. In the low state, the output will be pulled to less than 0.8V.
- 5) RD-/+: These are the differential receiver outputs. They are internally AC-coupled 100 differential lines which should be terminated with 100Ω (differential) at the user SERDES.
- 6) TD-/+: These are the differential transmitter inputs. They are internally AC-coupled, differential lines with 100Ω differential termination inside the module.

Recommended Interface Circuit





Regulatory Compliance

XENYA SFP-BIDI transceiver is designed to be Class I Laser safety compliant and is certified per the following standards:

Feature	Agency	Standard	Certificate / Comments
Laser Safety	FDA	CDRH 21 CFR 1040 and Laser Notice No. 50	1120289-000
Product Safety	BST	EN 60825-1 : 2007 EN 60825-2 : 2004 EN 60950-1 : 2006	BT0905142009
Environmental protection	SGS	RoHS Directive 2002/95/EC	GZ0902008347/CHEM
EMC	WALTEK	EN 55022:2006+A1:2007 EN 55024:1998+A1+A2:2003 -	WT10093768-D-E-E

Ordering information

Part Number	Product Description			
XSB541-80LY	1550nm, 1.25Gbps, LC,80km,	0℃~+70℃, With Digital Diagnostic Monitoring		

Important Notice

Performance figures, data and any illustrative material provided in this data sheet are typical and must be specifically confirmed in writing by XENYA before they become applicable to any particular order or contract. In accordance with the XENYA policy of continuous improvement specifications may change without notice.

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E-mail: info@xenya.si
Web: www.xenya.si